Product / Process Change Notification



N° 2021-058-A1

Dear Customer,

Please find attached our Infineon Technologies AG PCN:

Removal of additional label on the module card box

Important information for your attention:

- Please respond to this PCN by indicating your decision on the approval form, sign it and return to your sales partner before 21 July 2021
- Infineon aligns with the widely-recognized JEDEC STANDARD "JESD46", which stipulates: "Lack of acknowledgement of the PCN within 30 days constitutes acceptance of the change."

Your prompt reply will help Infineon Technologies to assure a smooth and well executed transition. If Infineon does not hear from your side by the due date, we will assume your full acceptance to this proposed change and its implementation.

Your attention and response to this matter is greatly appreciated.

Infineon Technologies AG Postal Address Headquarters: Am Campeon 1-15, D-85579 Neubiberg, Phone +49 (0)89 234-0 Chairman of the Supervisory Board: Dr. Wolfgang Eder Management Board: Dr. Reinhard Ploss (CEO), Dr. Helmut Gassel, Jochen Hanebeck, Constanze Hufenbecher, Dr. Sven Schneider Registered Office: Neubiberg Commercial Register: München HRB 126492

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Products affected: Please refer to attached affected product list "pcn_2021-058-A1_[customer-no].pdf"

• Detailed Change Information:

Subject: Five additional products are also effected by change as in PCN 2021-058-A. IHM A and IHV B are packed in card boxes. These boxes can have a capacity of one to four modules. After sealing the package with the shipment label, additional labels of the enclosed modules are placed on the box. These labels are going to be removed since the identical information is available on the enclosed modules.

Reason: Simplification and standardization of production process

Description: Old

New

Copies of module labels attached Modu to the carton box

Module labels removed



Product Identification:
Date code

Impact of Change:
No impact on electrical performance. Quality and reliability verified by qualification. There is no change in form, fit and function There is no change in the assembly process at Infineon.

Attachment:
Affected product list pcn_2021-058-A1_[customer-no].pdf

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► Time Schedule:

- Final qualification report:
- First samples available:
- Intended start of delivery:

From beginning of September 2021 onwards

If you have any questions, please do not hesitate to contact your local Sales office.

n.a.

n.a.

PCN2021-058-A1

Removal of additional label on the module card box



Affected products sold to DIGI-KEY (4002348)

Sales name	SP number	OPN	Package	Customer part number
FZ2400R33HE4	SP005559851	FZ2400R33HE4BPSA1	AG-IHVB190	FZ2400R33HE4BPSA1
FZ825R33HE4D	SP005550793	FZ825R33HE4DBPSA1	AG-IHVB130	FZ825R33HE4DBPSA1